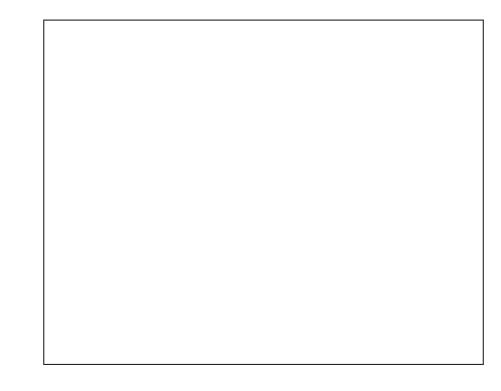


TABLE 1

Variant	Label text	
001	ChangeMel	
002	ChangeMe!	

ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9104	REV: A	SUN REV:	Not In VersionControl
IGNORE ->				
PLOT NAME = Top Assembly Drawing	GENERATED : 9/10/2	2013 10:49:32	AM	TEXAS INSTRUMENTS



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9104	REV: A	SUN REV:	Not In VersionControl
		IGNORE ->	Bottom Overlay <- 390V	
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/10/2	2013 10:49:33	: AM	TEXAS INSTRUMENTS

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